# CM1263-06DE

# Low Capacitance ESD Protection for High-Speed Serial Interfaces

#### Features

- 6 Channels of ESD Protection
- 1 pF Loading Capacitance per Channel Typical
- ±8 kV ESD Protection (IEC 61000-4-2, Contact Discharge)
- ±15 kV ESD Protection (IEC 61000–4–2, Air Discharge)
- These Devices are Pb-Free and are RoHS Compliant

### Applications

- LCD and Camera Data Lines in Wireless Handsets that Use High-Speed Serial Interfaces such as MDDI, MIPI, MVI and MPL
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- Wireless Handsets
- Handheld PCs/PDAs
- LCD and Camera Modules



# **ON Semiconductor®**

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UDFN12 DE SUFFIX CASE 517BD

**BLOCK DIAGRAM** 



## MARKING DIAGRAM



(\*Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
CM1263-06DE	UDFN	3000/Tape & Reel
	(Pb-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

### Table 1. PIN DESCRIPTIONS

Pin	Description		
1	V <sub>N</sub> *		
2	(CH1) ESD Channel #1		
3	V <sub>N</sub> *		
4	V <sub>N</sub> *		
5	(CH2) ESD Channel #2		
6	V <sub>N</sub> *		
7	(CH3) ESD Channel #3		
8	$V_{P2}$ for Channels 2, 3, and 4		
9	(CH4) ESD Channel #4		
10	(CH5) ESD Channel #5		
11	$V_{P1}$ for Channels1, 5, and 6		
12	(CH6) ESD Channel #6		
DAP*	Backside, GND Pad, V <sub>N</sub> *		

#### PACKAGE / PINOUT DIAGRAM



12-Lead UDFN Package

## CM1263-06DE

### **SPECIFICATIONS**

### Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Operating Supply Voltage (V <sub>P</sub> - V <sub>N</sub> )	6.0	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-65 to +150	°C
DC Voltage at any channel input	(V <sub>N</sub> – 0.5) to (V <sub>P</sub> + 0.5)	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
VP	Operating Supply Voltage (V <sub>P</sub> -V <sub>N</sub> )			3.3	5.5	V
Ι <sub>Ρ</sub>	Operating Supply Current	$V_P$ = 3.3 V, $V_N$ = 0 V (per V <sub>P</sub> pin)			8.0	μΑ
V <sub>F</sub>	Diode Forward Voltage Top Diode Bottom Diode	$T_A = 25^{\circ}C, I_F = 8 \text{ mA}, V_P = 3.3 \text{ V}, V_N = 0 \text{ V}$	0.60 0.60	0.80 0.80	0.95 0.95	V
I <sub>LEAK</sub> Channel Leakage Current	Channel Leakage Current	$T_A = 25^{\circ}C; V_P = 3.3 V, V_N = 0 V$ (Channel 1)			250	nA
		V <sub>P</sub> = 3.3 V, V <sub>N</sub> = 0 V (Channels 1–6)			1000	nA
I <sub>R</sub>	Reverse (Leakage Current)	V <sub>P</sub> = floating; V <sub>N</sub> = 0 V (per channel)			1000	nA
C <sub>IN</sub>	Channel Input Capacitance	At 1 MHz, V <sub>P</sub> = 3.3 V, V <sub>N</sub> = 0 V, V <sub>IN</sub> = 0 V		0.88	1.2	pF
$\Delta C_{IN}$	Channel Input Capacitance Matching	At 1 MHz, $V_P$ = 3.3 V, $V_N$ = 0 V, $V_{IN}$ = 0 V		0.02		pF
C <sub>MUTUAL</sub>	Mutual Capacitance between signal pin and adjacent signal pin	At 1 MHz, $V_P$ = 3.3 V, $V_N$ = 0 V, $V_{IN}$ = 0 V		0.11		pF
Peak Dia input, in a) Con IEC 6 b) Air	ESD Protection Peak Discharge Voltage at any channel input, in system a) Contact discharge per	$T_A = 25^{\circ}C$ (Notes 2 and 3)	±8			kV
	IEC 61000-4-2 standard b) Air discharge per IEC 61000-4-2 standard		±15			
V <sub>CL</sub>	Channel Clamp Voltage Positive Transients Negative Transients	$T_A = 25^{\circ}C$ , $I_{PP} = 1$ A, $t_P = 8/20 \ \mu S$ (Note 3)		+9.96 -1.6		V
R <sub>DYN</sub>	Dynamic Resistance Positive Transients Negative Transients	$T_A = 25^{\circ}C$ , $I_{PP} = 1$ A, $t_P = 8/20 \ \mu S$ Any I/O pin to Ground (Note 3)		0.96 0.5		Ω

All parameters specified at T<sub>A</sub> = -40°C to +85°C unless otherwise noted.
Standard IEC 61000-4-2 with C<sub>Discharge</sub> = 150 pF, R<sub>Discharge</sub> = 330 Ω, V<sub>P</sub> = 3.3 V, V<sub>N</sub> grounded.
These measurements performed with no external capacitor on V<sub>P</sub> (V<sub>P</sub> floating).

#### PACKAGE DIMENSIONS

UDFN12, 2.5x1.35, 0.4P CASE 517BD ISSUE O



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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